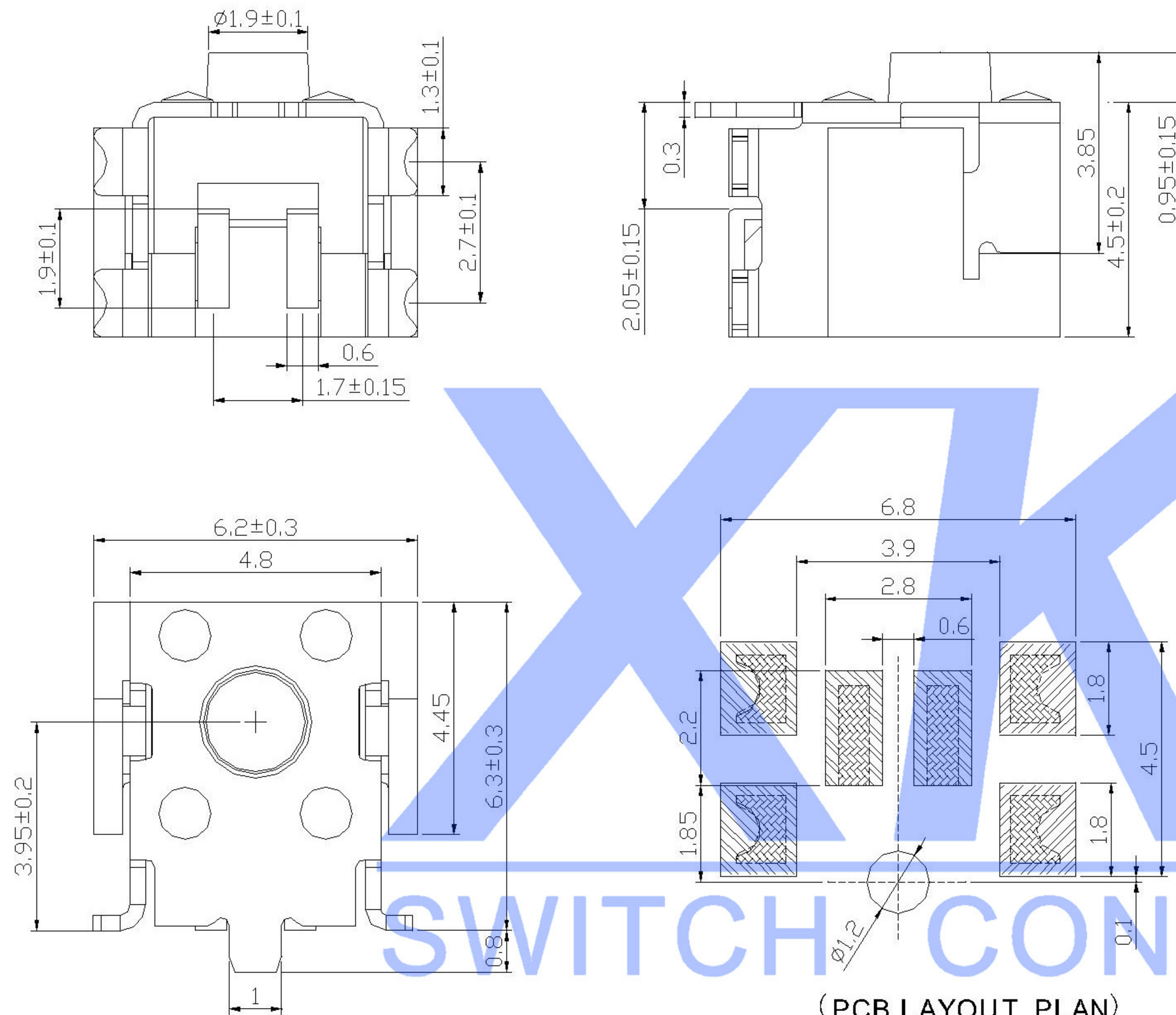
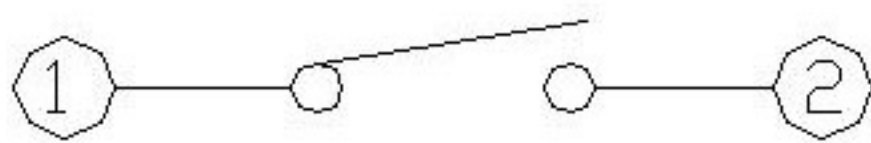




(PCB LAYOUT PLAN)



(CIRCUIT DIAGRAM)

SPECIFICATION

Contact Rating :	50mA,12V DC
Contact Resistance :	100mΩ max
Insulation Resistance :	100mΩ min.500V DC
Dielectric Strength :	250V AC/1minute
Travel:	0.25mm
Operating Temp:	-30℃~+85℃
Storage Temp:	-30℃~+80℃

PAPT NO	TS-1109TP-X
Operating Force	A:100gf B:160gf C:260gf
Height	H: 3.85

⑤	Terminal	—	2	Brass (0.30t)	Plating silvering	—
④	Contact	—	1	F.ag/Sus	Natural	—
③	Base	—	1	Pa46		—
②	Cover	—	1	Spcc	Plating Nickel	—
①	Keystake	—	1	Pa46		—
ITEM	PAPT NAMF	TER.NO	QTY	MATERIAL	FINISHING	REMARK

					units: mm
△x					tolerance:
△x					X.X ±0.2mm
△x					X.XX ±0.1mm
MARK	DESCRIPTION	DATE	REVISED	APPROVED	X.XXX ±0.05mm
REVISIONS					UNSPECIFIED TOLERANCES
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DSND		DATE		SCALE: N/A	MODEL TYPE:
DWN		DATE		VIEW:	TACT SWITCH
CHKD		DATE		UNIT: mm	PART NO.:
APPD		DATE		SIZE: A4	DWG NO.:
XKB INDUSTRIAL PRECISION CO.,LIMITED					TS-1109TP-X
		WEIGHT	SHEET	REVISION	
		1.0g	1/1	A0	